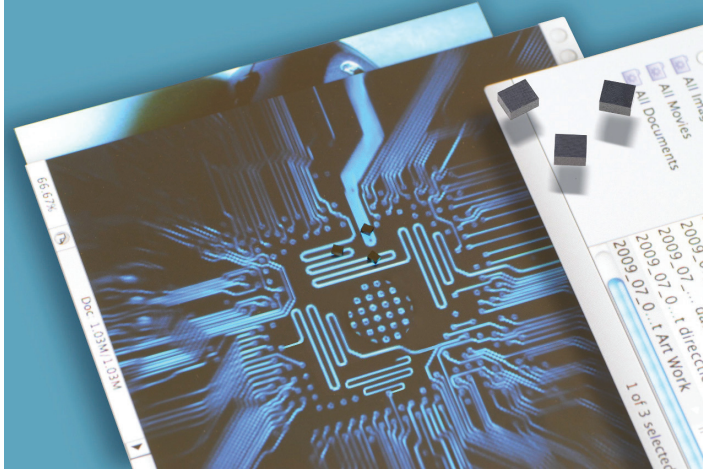


Coiltronics MPI4040

High Current, High Frequency, Miniature Power Inductors



Product description:

- Handles high transient inrush current spikes
- Magnetically shielded
- Frequency range 20kHz to 10MHz
- Inductance range from 0.09µH to 22µH
- Current range from 1.1A to 32.0A
- 4.7 x 4.31 footprint surface mount package in 1.2, 1.5, 1.85 or 2.0mm heights
- Rugged construction
- Halogen free, lead free, RoHS compliant

Applications:

- Handheld/mobile devices
- Portable media players
- GPS/PDAs
- MP3 Players
- Battery operated devices
- Notebook/netbook
- Tablets/smartbooks
- LCD Displays
- LED Drivers
- POL Converters

Environmental data:

- Storage temperature range (component): -55°C to +125°C
- Operating temperature range: -55°C to +125°C (Ambient plus self temperature rise)
- Solder reflow temperature: J-STD-020D compliant



The Coiltronics brand of magnetics (formerly of the Bussmann Division of Cooper Industries) is now part of Eaton's Electrical Group, Electronics Division.

Coiltronics is now part of Eaton
Same great products plus even more.



Powering Business Worldwide

Product specifications

Part Number ⁵	OCL ¹ ± 20% (µH)	Part Marking Designator	I _{rms} ² (Amps)	@ 25°C ³ (Amps)	DCR (mΩ) ± 20% @ 20°C	K-factor ⁴
R1 -- 1.2mm Height						
MPI4040R1-R10-R	0.09	A	8.00	32.0†	8.50	1401
MPI4040R1-R15-R	0.15	B	7.00	26.0†	11.0	989
MPI4040R1-R22-R	0.23	C	5.50	21.0	18.0	814
MPI4040R1-R33-R	0.33	D	4.40	17.0	28.0	659
MPI4040R1-R47-R	0.47	E	5.20	11.5	20.0	1295
MPI4040R1-R68-R	0.68	F	3.30	9.00	51.0	461
MPI4040R1-1R0-R	1.0	G	3.70	7.70	40.0	990
MPI4040R1-1R5-R	1.5	H	3.00	6.50	60.0	732
MPI4040R1-2R2-R	2.2	I	2.60	5.90	80.0	623
MPI4040R1-3R3-R	3.3	J	2.20	5.10	115	481
MPI4040R1-4R7-R	4.7	K	1.80	3.80	180	411
MPI4040R1-6R8-R††	6.8	L	1.50	3.20	250	344
MPI4040R1-100-R††	10	M	1.20	2.80	370	276
R2 -- 1.5mm Height						
MPI4040R2-R47-R	0.47	A	6.40	12.2	13.0	1403
MPI4040R2-1R0-R	1.0	B	4.60	8.90	25.0	935
MPI4040R2-1R5-R	1.5	C	3.80	7.60	37.0	701
MPI4040R2-2R2-R	2.2	D	3.20	5.70	58.0	647
MPI4040R2-3R3-R	3.3	E	2.60	5.40	76.0	495
MPI4040R2-4R7-R	4.7	F	2.20	4.30	105	421
MPI4040R2-6R8-R	6.8	G	1.80	3.40	158	351
MPI4040R2-100-R††	10.0	H	1.50	3.10	240	271

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0A_{dc}

2 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. De-rating is necessary for AC currents. Temperature rise is dependent upon several factors, including the PCB pad layout, trace thickness and width, air-flow and proximity to other heat generating components. It is recommended the part temperature not exceed 125°C under worst case operating conditions and therefore, the temperature rise should be verified in the end use application. Irms testing was performed on a 19.05mm long x 6.35mm wide x 0.070mm thick copper trace in still air.

3 I_{sat}: Peak current for approximately 30% rolloff at +25°C.

4 K-factor: Used to determine B_{p-p} for core loss (see graph). B_{p-p} = K * L * DI. B_{p-p}: (Gauss), K: (K-factor from table), L: (inductance in µH), DI (peak-to-peak ripple current in amps).

5 Part Number Definition: MPI4040RX-XXX-R

- MPI4040X = product code and size
- XXX = inductance value in all, "R" = decimal point
- If no "R" is present, then third digit equals the number of zeros
- "-R" suffix = RoHS compliant

† Transient pulse not to exceed 1 millisecond.

†† Maximum operating frequency less than 10MHz, consult factory for application specific values.

Part Number ⁵	OCL ¹ ± 20% (µH)	Part Marking Designator	I _{rms} ² (Amps)	I _{sat} ³ @ 25°C (Amps)	DCR (mΩ) ± 20% @ 20°C	K-factor ⁴
R3 -- 1.85mm Height						
MPI4040R3-R22-R	0.22	A	8.00	20.0	5.8	1870
MPI4040R3-R47-R	0.47	B	5.80	17.0	10.3	1530
MPI4040R3-1R2-R	1.2	C	4.00	9.40	32.0	732
MPI4040R3-1R5-R	1.5	D	3.80	8.20	36.0	673
MPI4040R3-2R2-R	2.2	E	3.40	7.90	48.0	543
MPI4040R3-3R3-R	3.3	F	3.00	6.60	60.0	432
MPI4040R3-4R7-R	4.7	G	2.30	4.80	92.0	374
MPI4040R3-6R8-R	6.8	H	2.00	4.50	120	306
MPI4040R3-100-R	10.0	I	1.50	3.80	213	251
MPI4040R3-150-R	15.0	J	1.30	3.00	285	213
MPI4040R3-220-R ^{††}	22.0	K	1.10	2.20	408	174
R4 -- 2.0mm Height						
MPI4040R4-R22-R	0.22	A	10.1	15.0	5.3	2405
MPI4040R4-R33-R	0.33	B	9.50	12.8	6.0	1870
MPI4040R4-R47-R	0.45	C	8.10	11.5	8.2	1530
MPI4040R4-1R0-R	1.0	D	5.70	8.20	17.0	990
MPI4040R4-1R5-R	1.5	E	4.90	6.90	23.0	802
MPI4040R4-2R2-R	2.2	F	3.90	5.70	35.0	673
MPI4040R4-3R3-R ^{††}	3.3	G	3.30	4.50	49.0	510
MPI4040R4-4R7-R ^{††}	4.7	H	2.90	3.90	67.0	455
MPI4040R4-6R8-R ^{††}	6.8	I	2.40	3.20	91.0	374
MPI4040R4-100-R ^{††}	10.0	J	1.90	2.60	148	306
MPI4040R4-220-R ^{††}	22.0	K	1.30	1.80	316	203

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0A_{dc}

2 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. De-rating is necessary for AC currents. Temperature rise is dependent upon several factors, including the PCB pad layout, trace thickness and width, air-flow and proximity to other heat generating components. It is recommended the part temperature not exceed 125°C under worst case operating conditions and therefore, the temperature rise should be verified in the end use application. Irms testing was performed on a 19.05mm long x 6.35mm wide x 0.070mm thick copper trace in still air.

3 I_{sat}: Peak current for approximately 30% rolloff at +25°C.

4 K-factor: Used to determine B_{p-p} for core loss (see graph). B_{p-p} = K * L * DI. B_{p-p} : (Gauss), K: (K-factor from table), L: (inductance in µH), DI (peak-to-peak ripple current in amps).

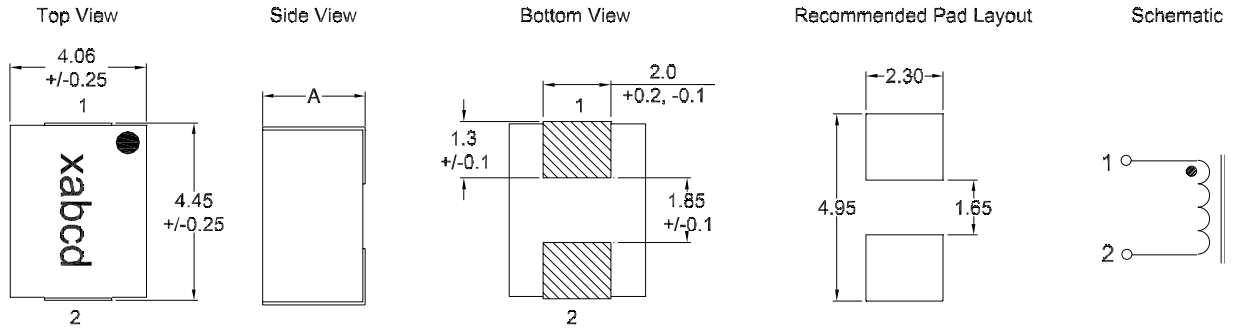
5 Part Number Definition: MPI4040RX-XXX-R

- MPI4040X = product code and size
- XXX = inductance value in all, "R" = decimal point
- If no "R" is present, then third digit equals the number of zeros
- "-R" suffix = RoHS compliant

† Transient pulse not to exceed 1 millisecond.

†† Maximum operating frequency less than 10MHz, consult factory for application specific values.

Dimensions - mm

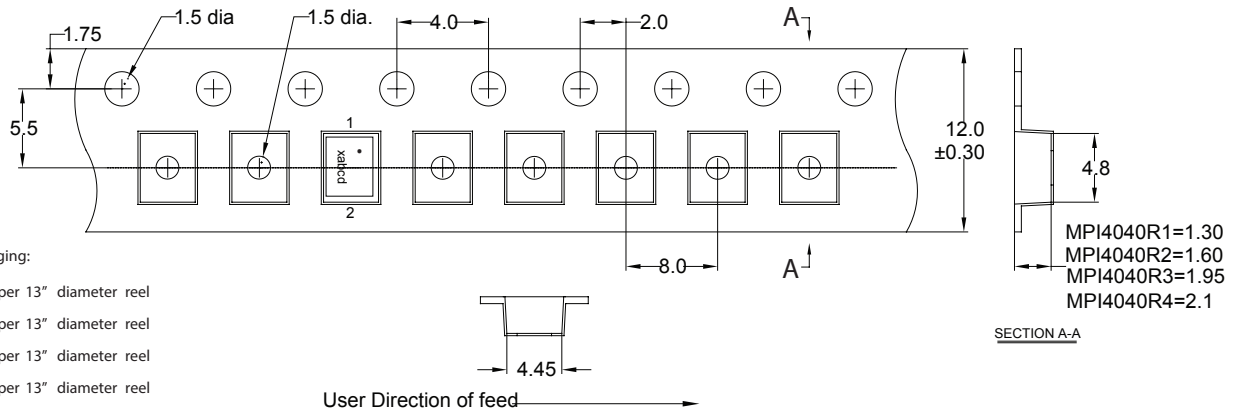


Part #	A Max
MPI4040R1-xxx-R	1.2
MPI4040R2-xxx-R	1.5
MPI4040R3-xxx-R	1.8
MPI4040R4-xxx-R	2.0

Part Marking : xabcd
 x = height: 1 = R1 (1.2mm), 2 = R2 (1.5mm), 3 = R3 (1.85mm), 4 = R4 (2.0mm)
 a = inductance value per the "Part Marking Designator" letter code in table above
 b = Bi-weekly date code
 c = Last digit of year manufactured
 d = Revision level

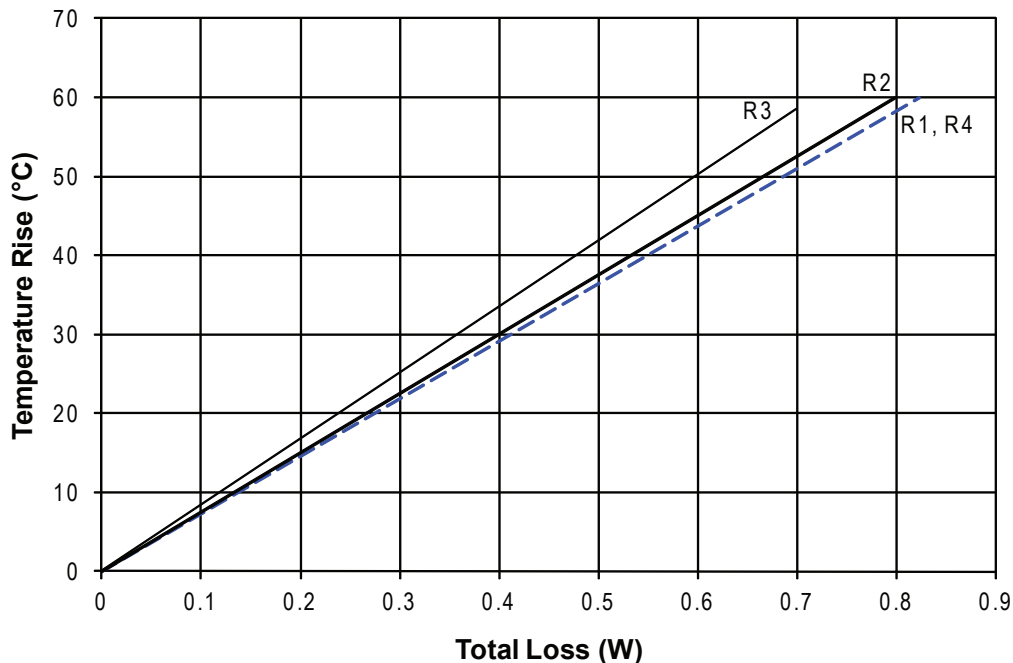
Soldering surfaces to be coplanar within 0.1016 millimeters
 PCB tolerances +/- 0.1mm unless otherwise specified
 Do not route traces or vias underneath the inductor

Packaging information - mm

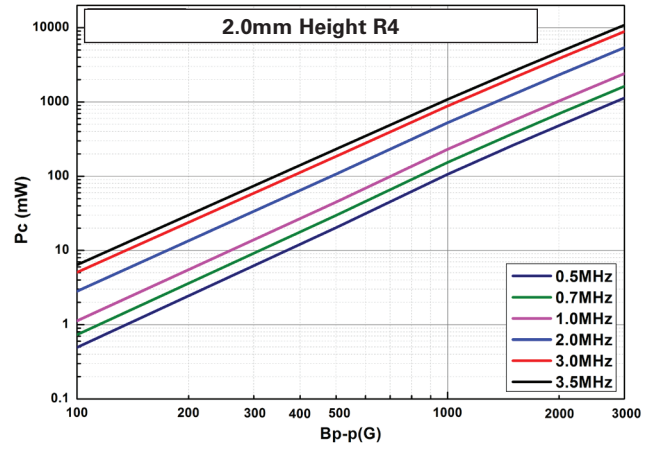
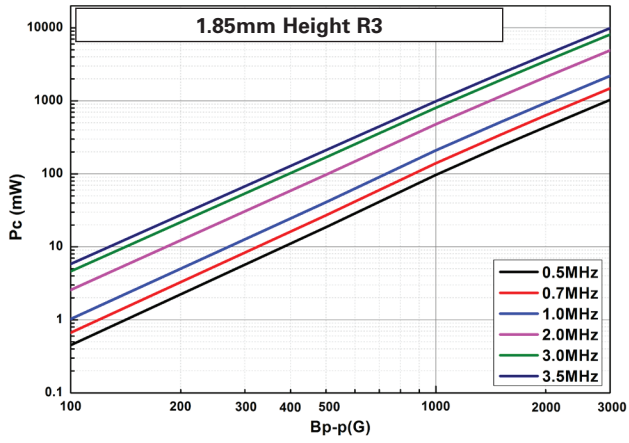
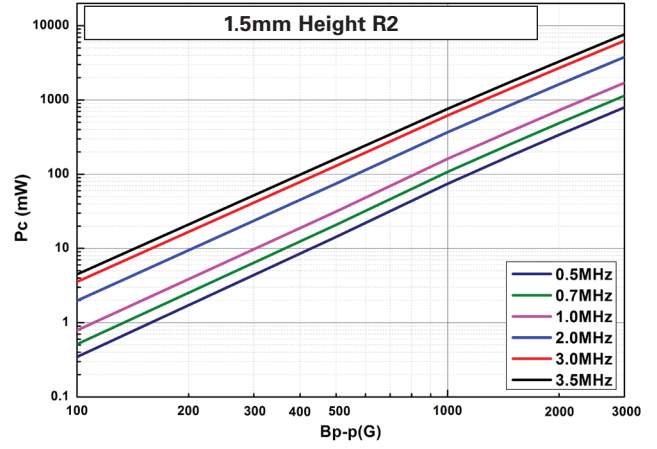
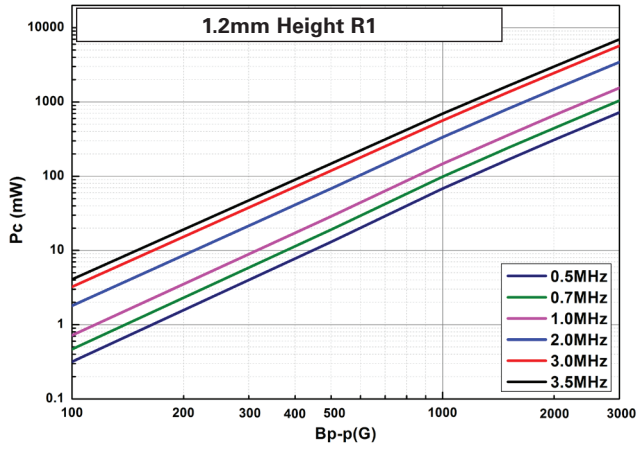


- Supplied in tape and reel packaging:
- MPI4040R1 = 5500 parts per 13" diameter reel
 - MPI4040R2 = 4500 parts per 13" diameter reel
 - MPI4040R3 = 3500 parts per 13" diameter reel
 - MPI4040R4 = 3000 parts per 13" diameter reel

Temperature rise vs. total loss

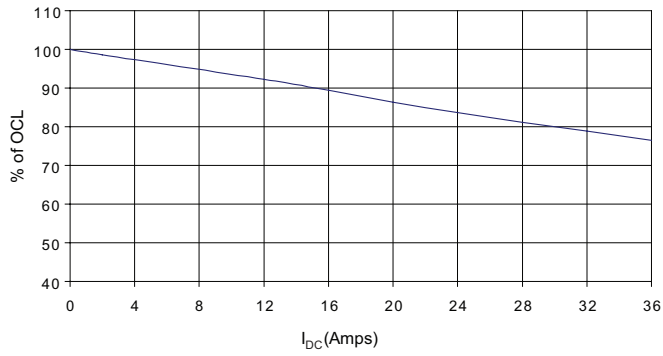


Core loss

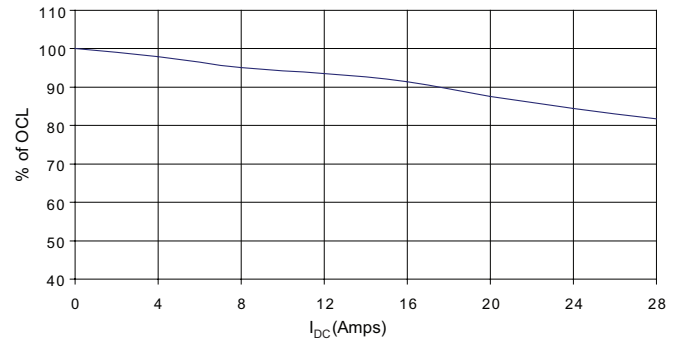


1.2mm Height R1 inductance characteristics — % of OCL vs. I_{DC}

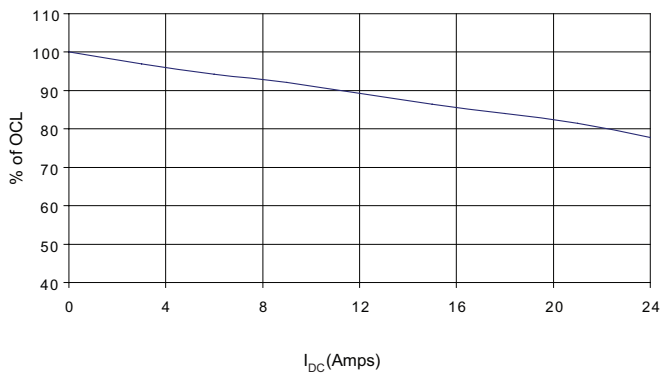
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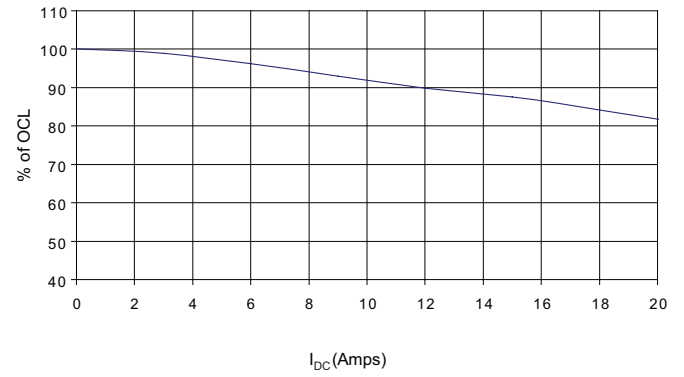
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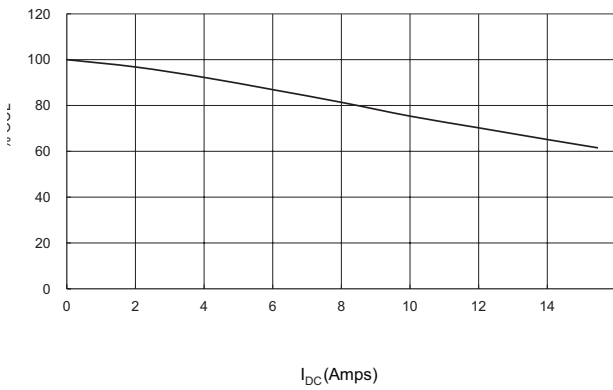
MPI4040R1-R22-R



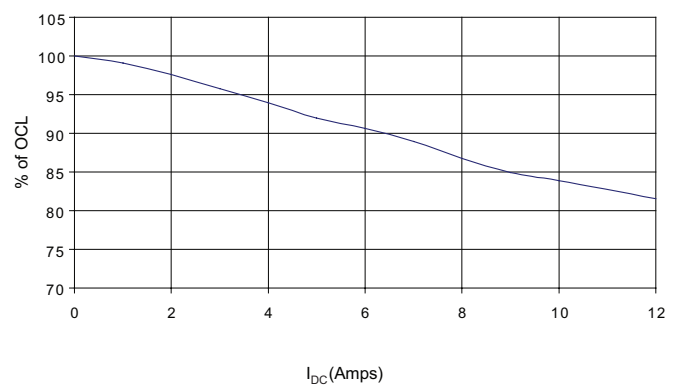
MPI4040R1-R33-R



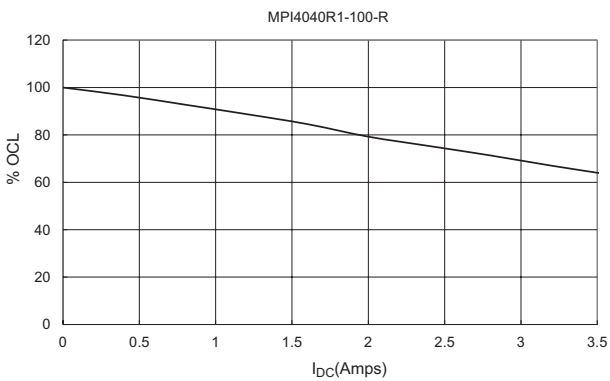
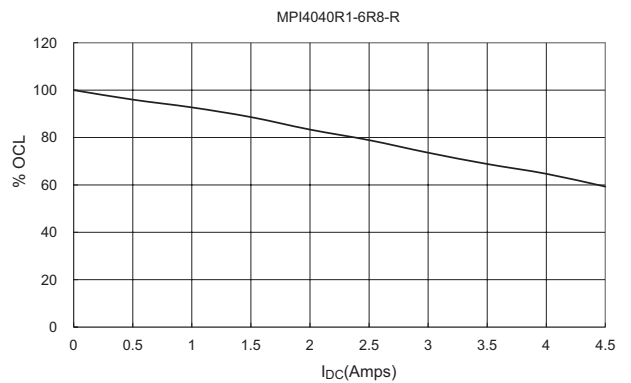
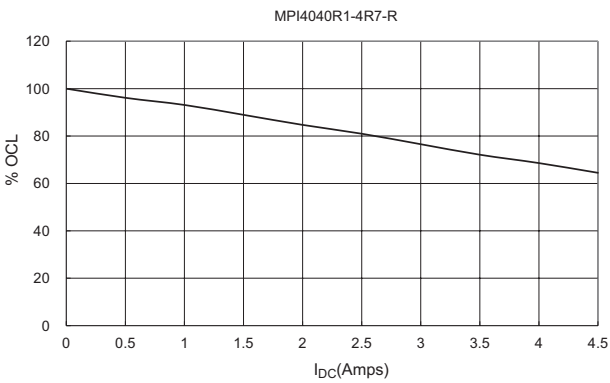
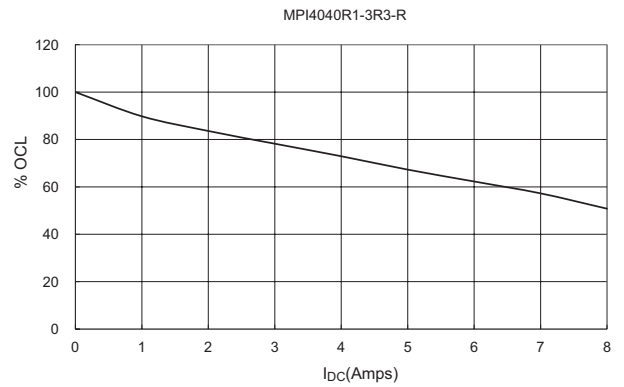
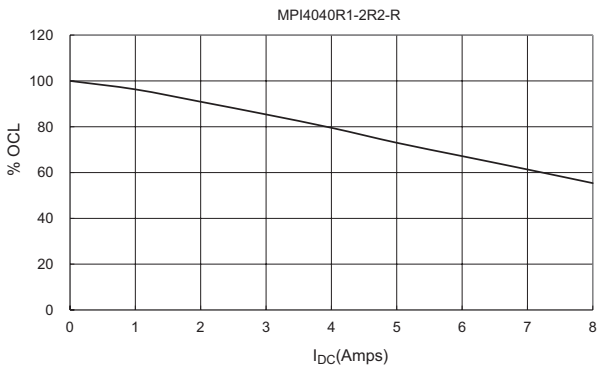
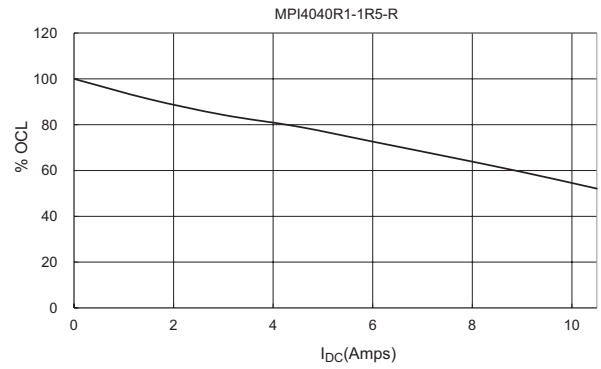
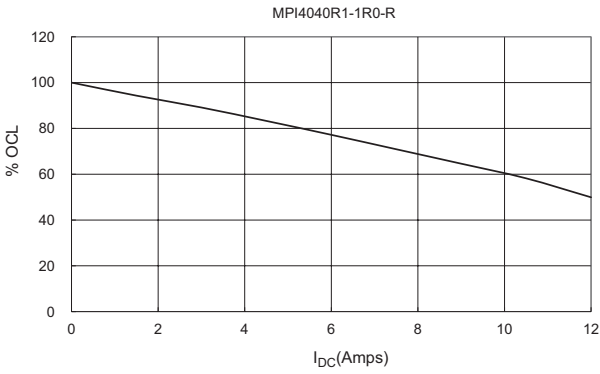
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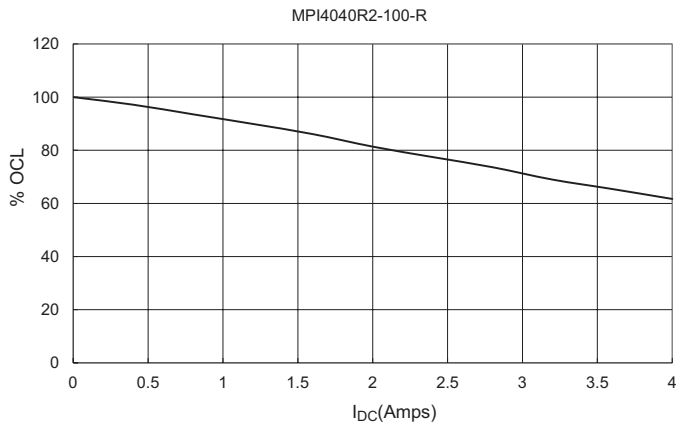
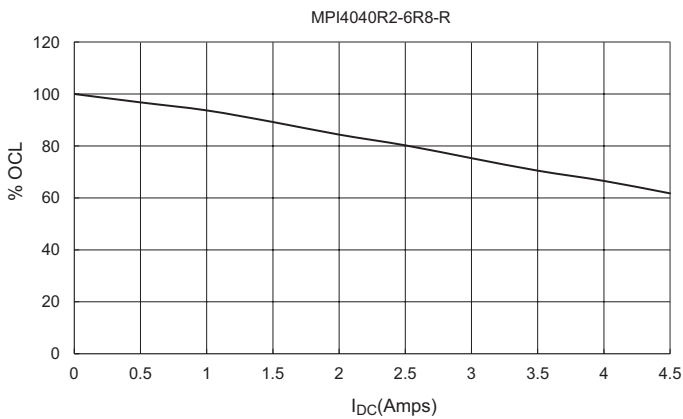
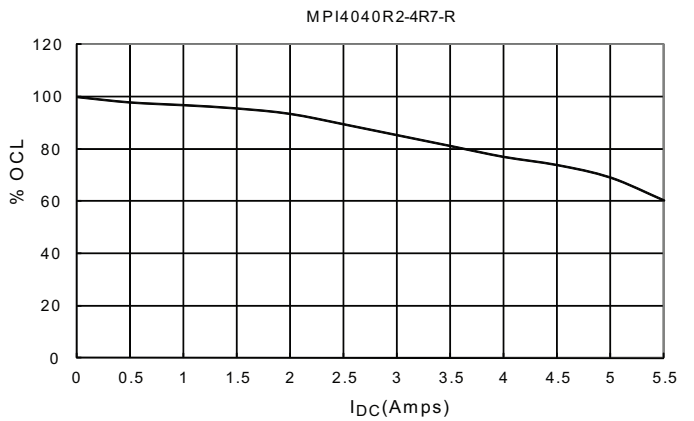
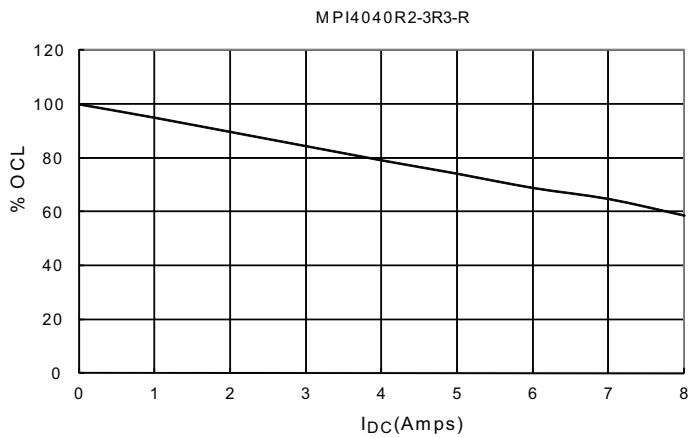
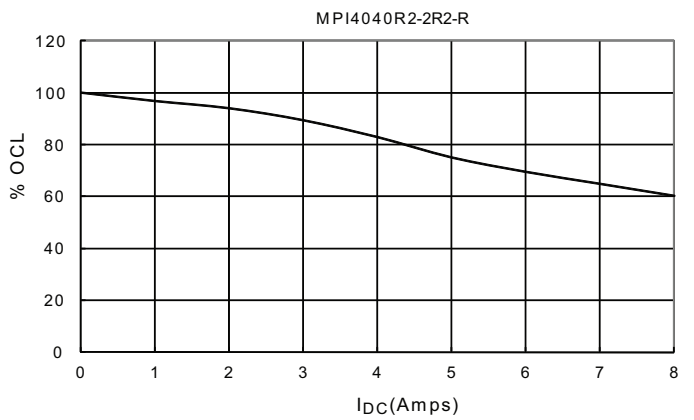
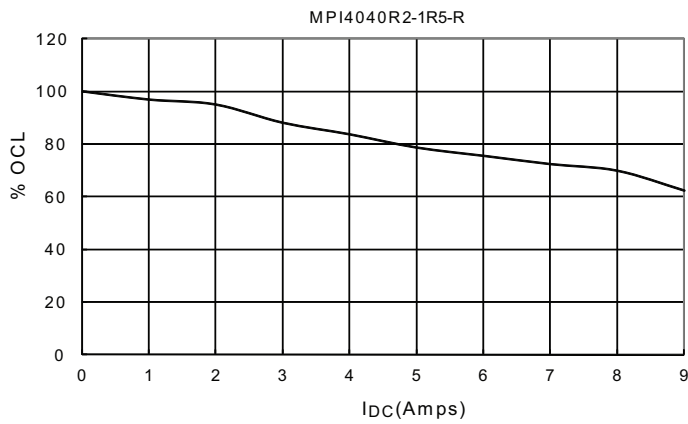
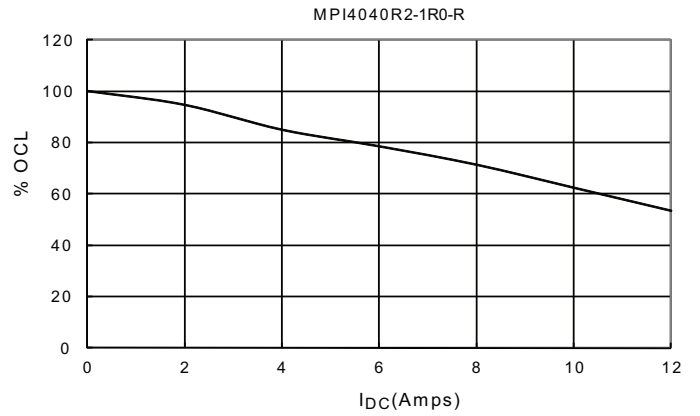
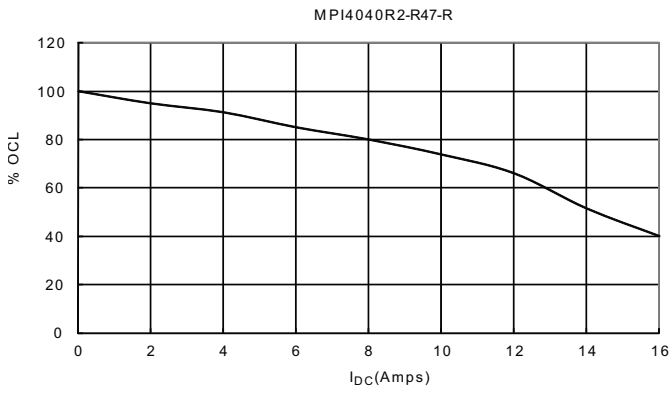
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1.2mm Height R1 inductance characteristics — % of OCL vs. I_{DC}

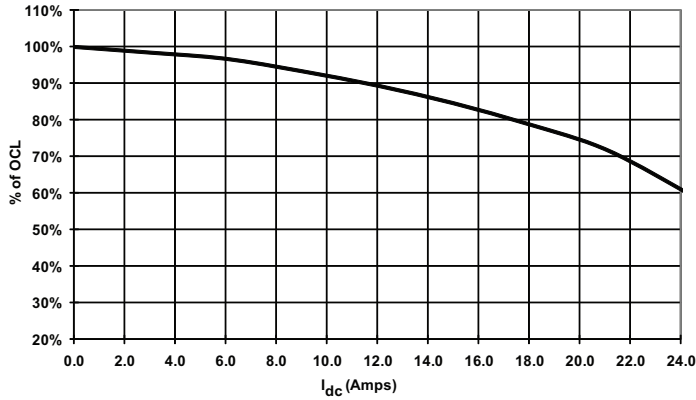


1.5mm Height R2 inductance characteristics — % of OCL vs. I_{DC}

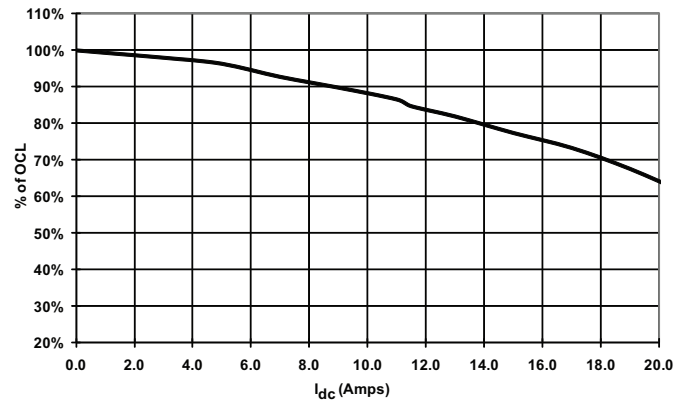


1.85mm Height R3 inductance characteristics — % of OCL vs. I_{DC}

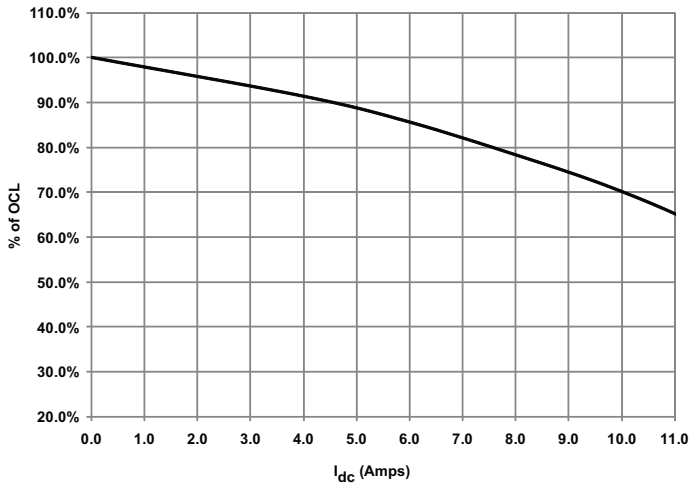
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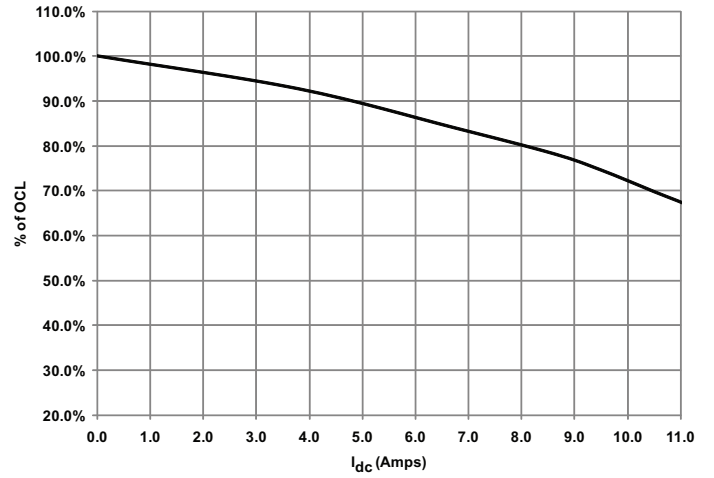
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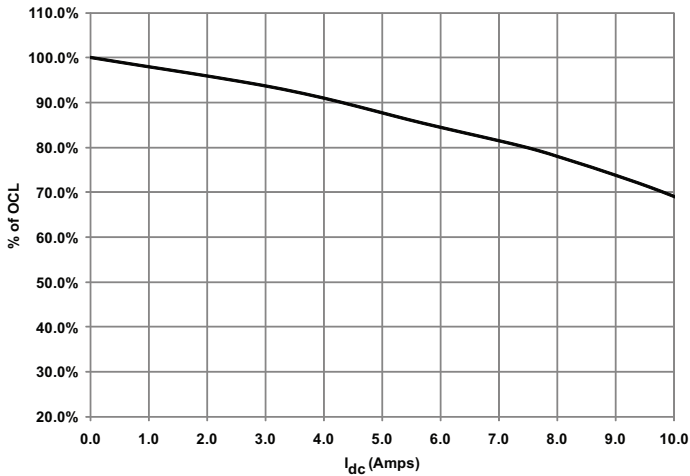
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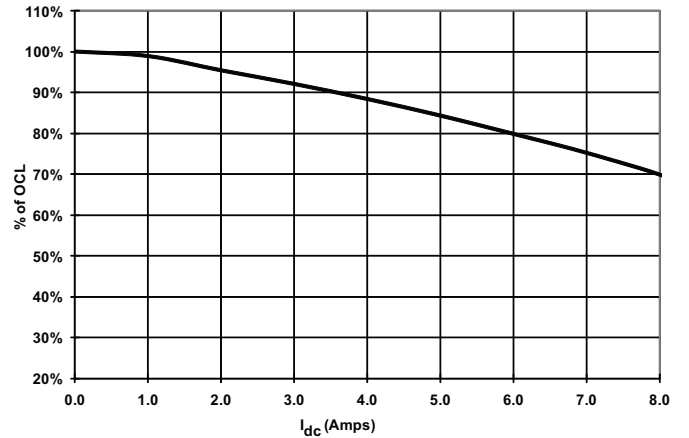
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MPI4040R3-2R2-R

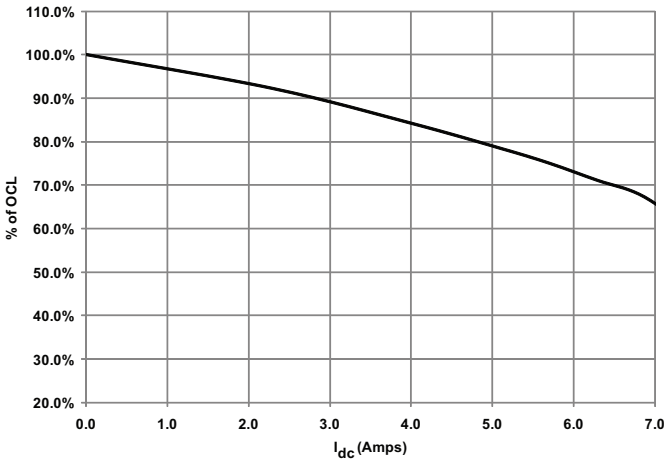


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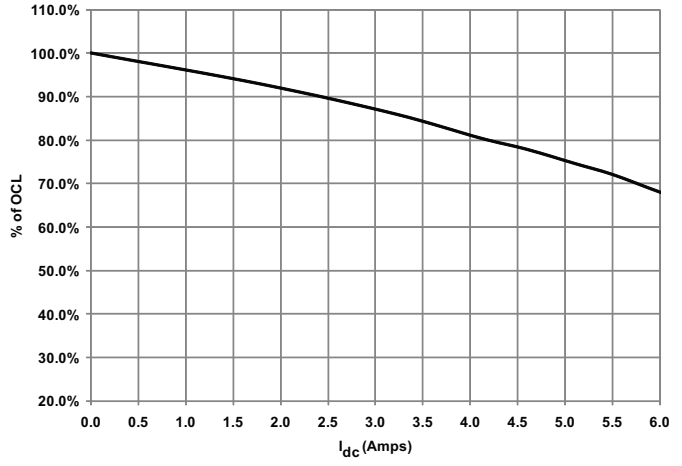


1.85mm Height R3 inductance characteristics — % of OCL vs. I_{DC}

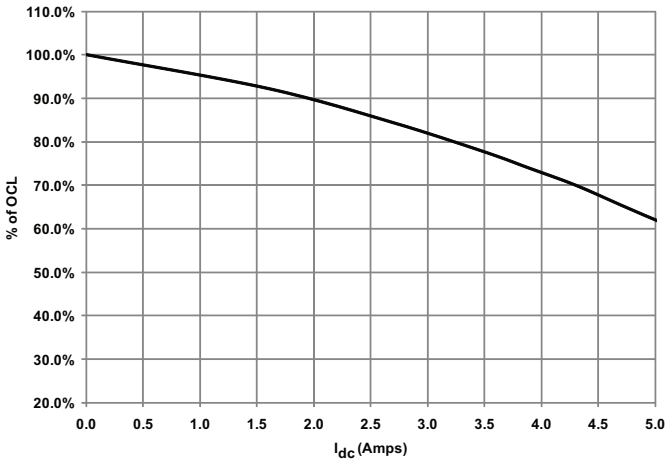
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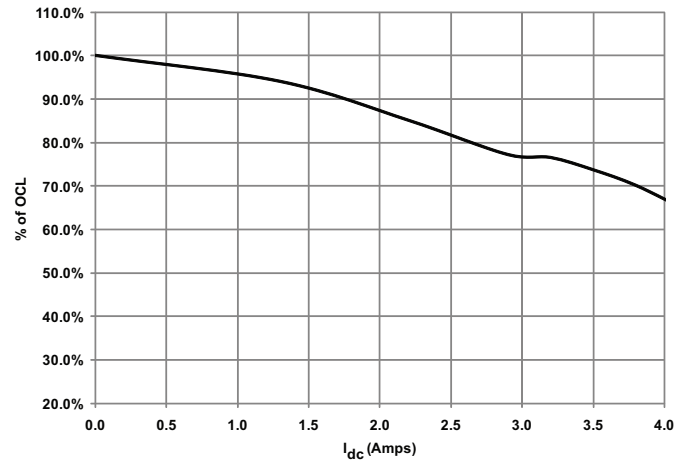
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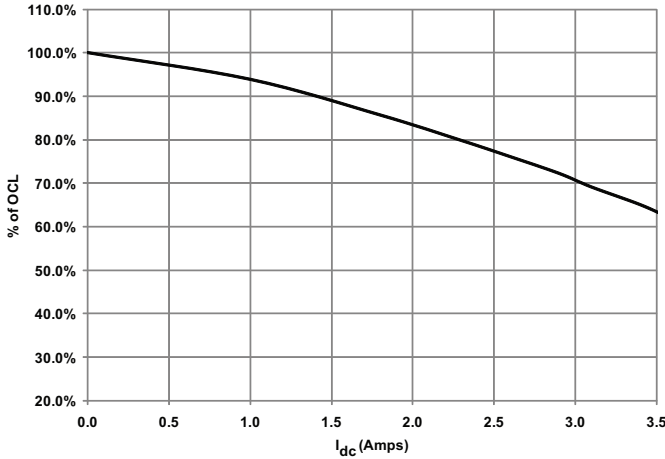
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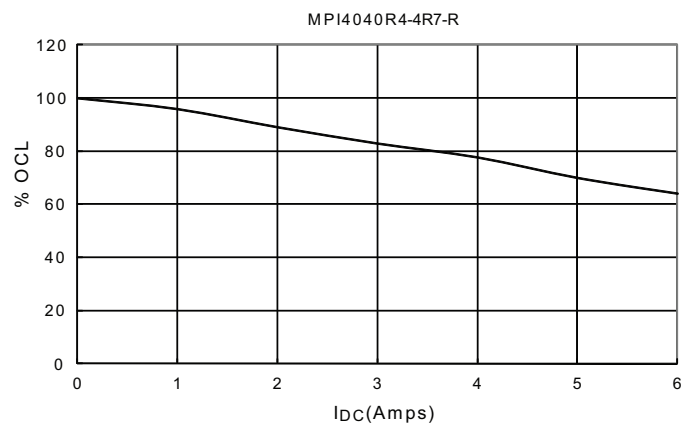
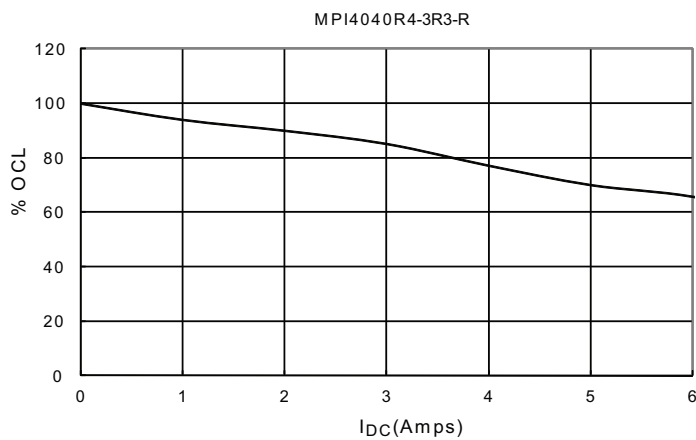
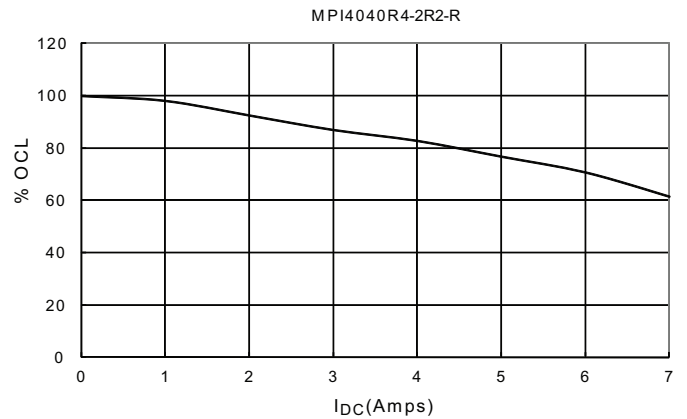
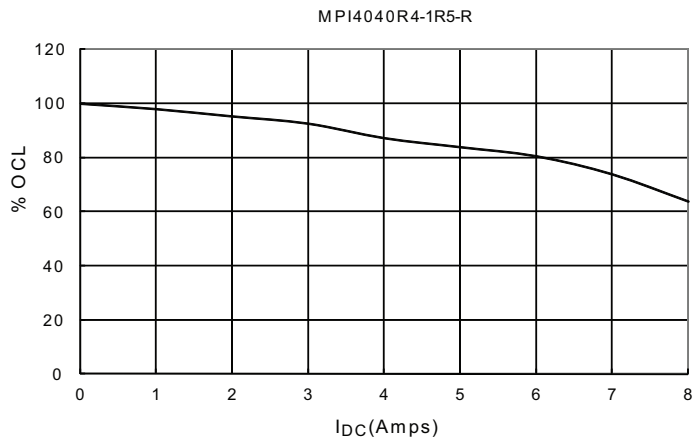
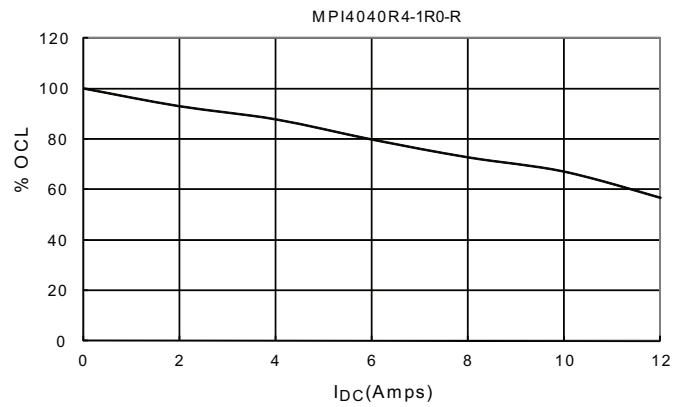
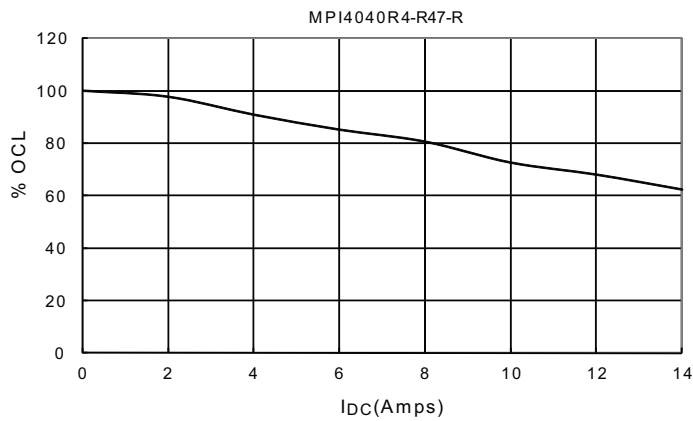
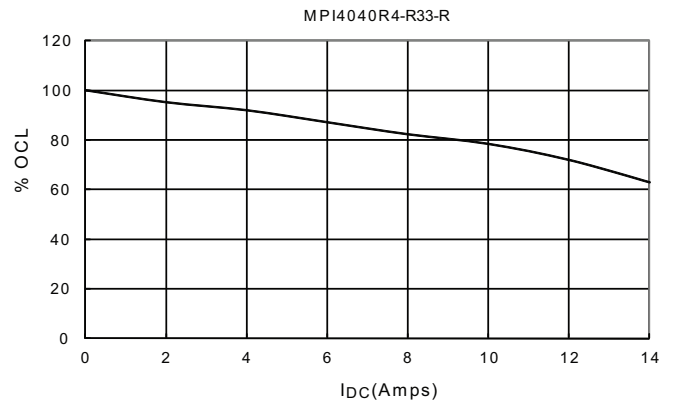
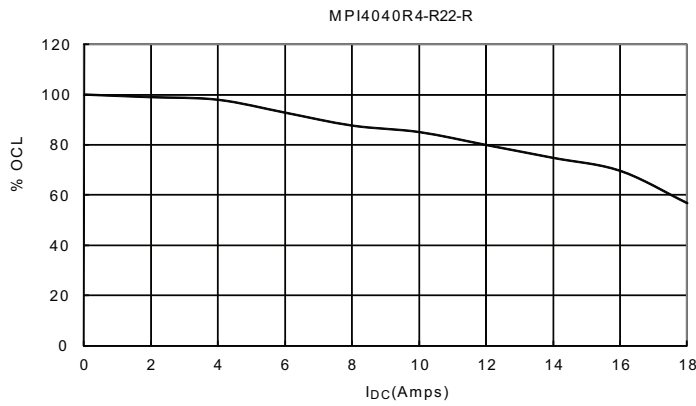
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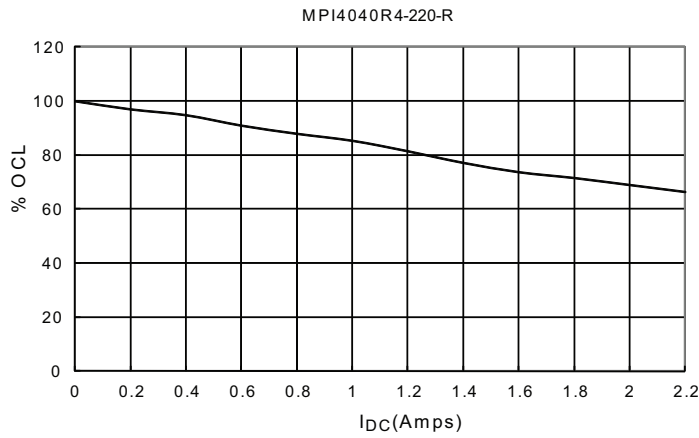
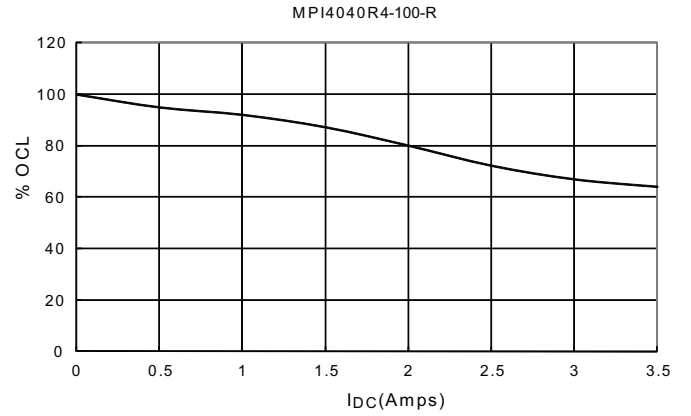
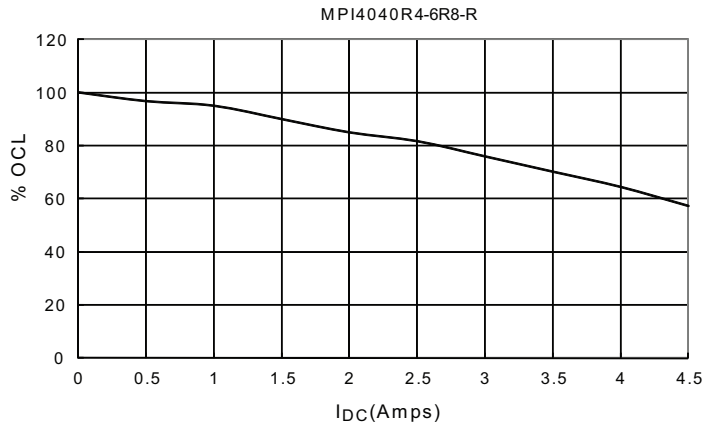
MPI4040R3-220-R



2.0mm Height R4 inductance characteristics — % of OCL vs. I_{DC}



2.0mm Height R4 inductance characteristics — % of OCL vs. I_{DC}



Solder reflow profile

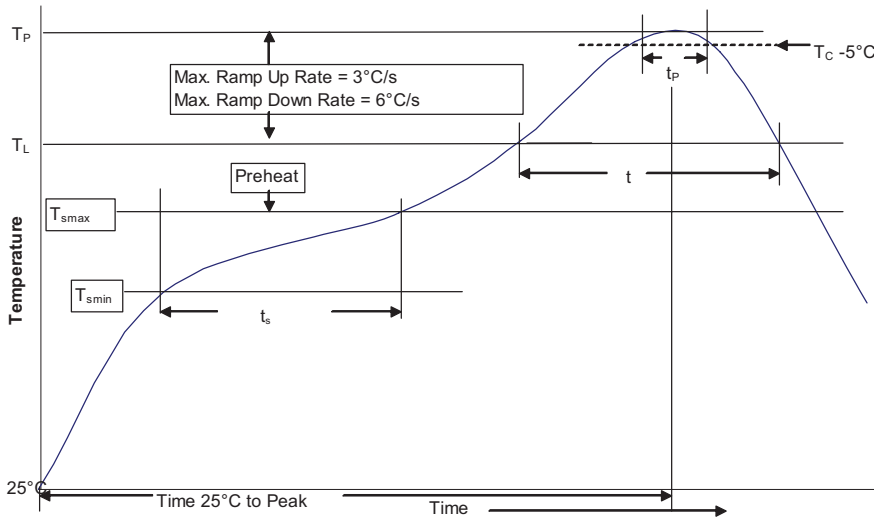


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume <350 mm ³	Volume ≥ 350 mm ³
<2.5 mm	235°C	220°C
≥ 2.5 mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume <350 mm ³	Volume $350 - 2000$ mm ³	Volume >2000 mm ³
<1.6 mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5 mm	250°C	245°C	245°C

Reference JEDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	100°C	150°C
• Temperature min. (T_{smin})	150°C	200°C
• Temperature max. (T_{smax})	60-120 Seconds	60-120 Seconds
• Time (T_{smin} to T_{smax}) (t_s)	3°C/ Second Max.	3°C/ Second Max.
Average ramp up rate T_{smax} to T_p	183°C	217°C
Liquidous temperature (T_L)	60-150 Seconds	60-150 Seconds
Time at liquidous (t_L)	Table 1	Table 2
Peak package body temperature (T_p)*	20 Seconds**	30 Seconds**
Time (t_p)** within 5 °C of the specified classification temperature (T_C)	6°C/ Second Max.	6°C/ Second Max.
Average ramp-down rate (T_p to T_{smax})	6 Minutes Max.	8 Minutes Max.
Time 25°C to Peak Temperature		

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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